

ON Semiconductor®

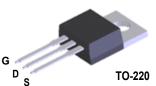
FDPF7N50U N-Channel UniFETTM Ultra FRFETTM MOSFET 500 V, 5 A, 1.5 Ω

Features

- $R_{DS(on)}$ = 1.5 Ω (Max.) @ V_{GS} = 10 V, I_D = 2.5 A
- Low Gate Charge (Typ.12.8 nC)
- Low C_{rss} (Typ. 9 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability

Applications

- LCD/LED TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply



Absolute Maximum Ratings

			S			
Symbol	Parameter Drain-Source Voltage			FDPF7N50U	Unit V	
V _{DSS}				500		
ID	Drain Current	- Continuous (T _C = 25°C - Continuous (T _C = 100°C		5 * 3.0 *	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	20 *	A	
V _{GSS}	Gate-Source voltage			±30	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	125	mJ	
I _{AR}	Avalanche Current		(Note 1)	5	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	8.9	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns	
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		31.3 0.25	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		ose,	300	°C	

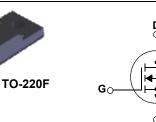
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* Drain current limited by maximum junction temperature. Thermal Characteristics

Symbol	Parameter	FDPF7N50U	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	4.0	20 M.V	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

Description UniFETTM MOSE

UniFETTM MOSFET is ON Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. UniFET Ultra FRFETTM MOSFET has much superior body diode reverse recovery performance. Its t_{rr} is less than 50nsec and the reverse dv/dt immunity is 20V/nsec while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore UniFET Ultra FRFET MOSFET can remove additional component and improve system reliability in certain applications that require performance improvement of the MOSFET's body diode. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Package Marking and Ordering Information						
Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDPF7N50U	FDPF7N50U	TO-220F			50	

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter Conditions		Min.	Тур.	Max	Unit
Off Charac	teristics		L			1
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	500			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_{C} = 125^{\circ}C$			25 250	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V			-100	nA
On Charac	teristics				1	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 2.5A		1.2	1.5	Ω
9 _{FS}	Forward Transconductance V_{DS} = 40V, I_D = 2.5A			2.5		S
Dynamic C	haracteristics	•			•	
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V,		720	940	pF
C _{oss}	Output Capacitance	f = 1.0MHz		95	190	pF
C _{rss}	Reverse Transfer Capacitance			9	13.5	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250V, I _D = 5A		6	20	ns
t _r	Turn-On Rise Time	$R_{G} = 25\Omega$		55	120	ns
t _{d(off)}	Turn-Off Delay Time			25	60	ns
t _f	Turn-Off Fall Time	(Note 4)		35	80	ns
Qg	Total Gate Charge	V _{DS} = 400V, I _D = 5A		12.8	16.6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		3.7		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		5.8		nC
Drain-Sour	rce Diode Characteristics and Maximur	n Ratings				<u> </u>
I _S	Maximum Continuous Drain-Source Diode Forward Current				5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				20	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 5A			1.6	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 5A		40		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100A/μs		0.04		μC

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

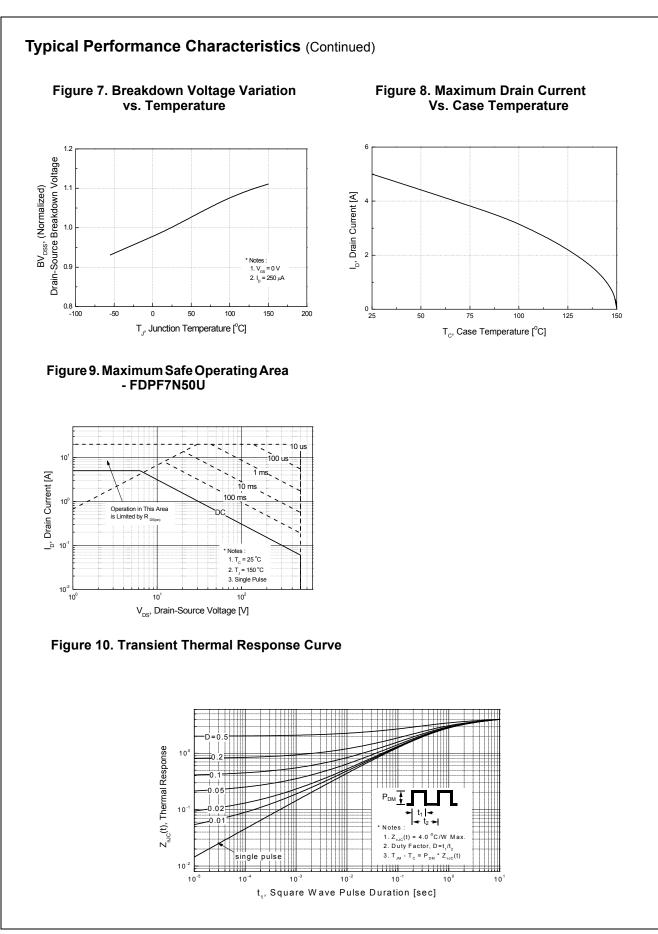
2. I_{AS} = 5A, V_{DD} = 50V, L=10mH, R_G = 25 Ω , Starting T_J = 25°C

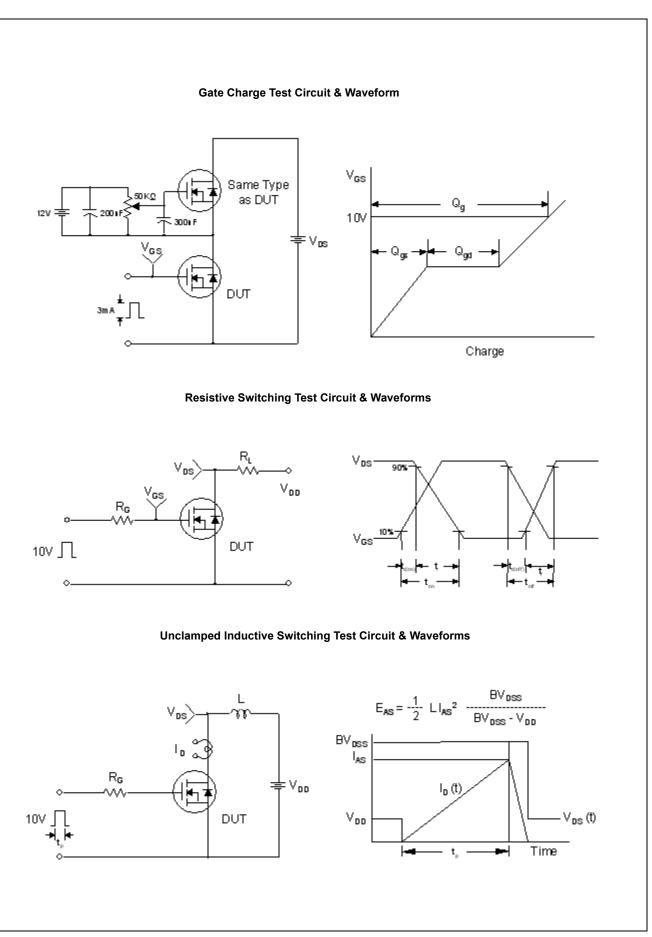
3. I_{SD} \leq 5A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics

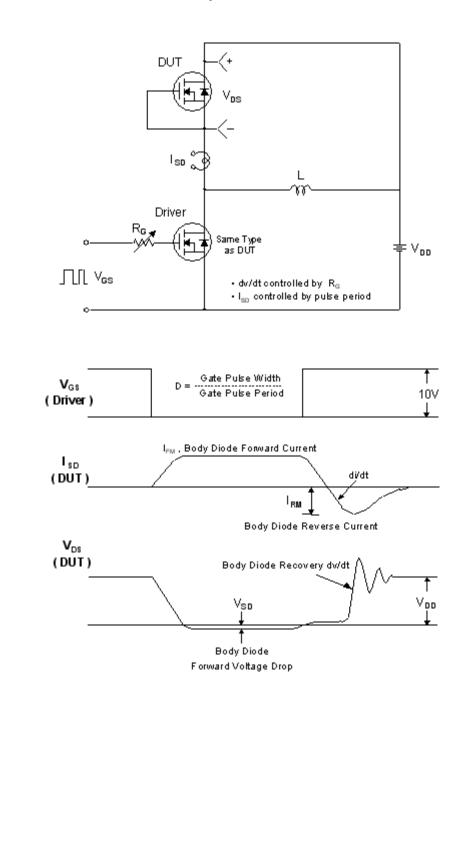


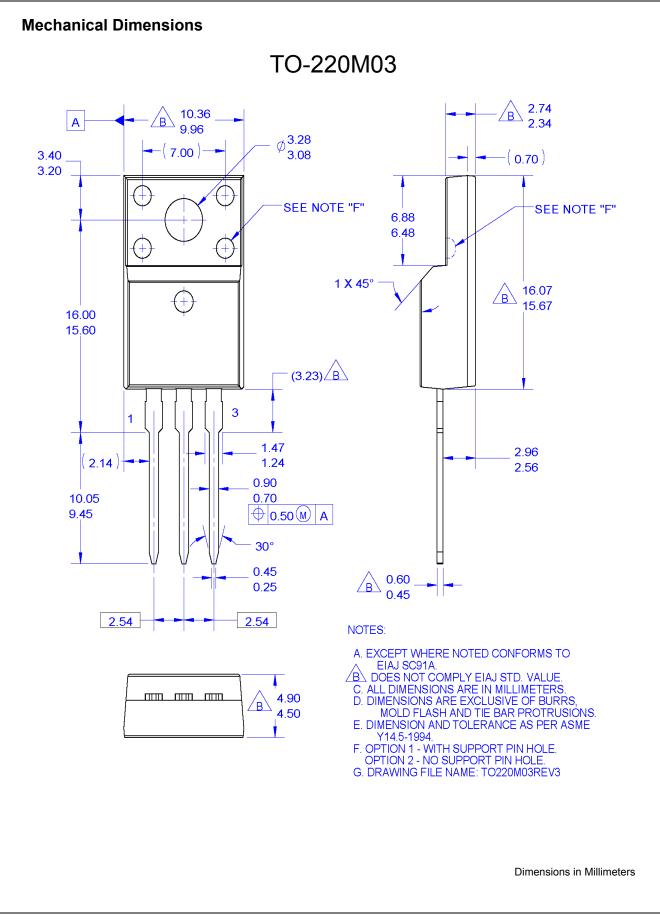
Typical Performance Characteristics Figure 1. On-Region Characteristics **Figure 2. Transfer Characteristics** 20 V_{GS} 10.0 V 8.0V 7.5 V 7.0 V 6.5 V 6.0 V Тор 10¹ 15 I_D , Drain Current [A] 150°C I_D, Drain Current [A] 5.5 V 5.0 V 10⁰ 10 25°0 * Notes : 1. 250µs Pulse Test 10 2. T_c = 25⁰C * Note : 1. V_{pe} = 40V 2. 250µs Pulse Test 0 0 10 20 30 40 50 10⁻² 10 2 4 6 8 V_{DS}, Drain-Source Voltage [V] V_{GS}, Gate-Source Voltage [V] Figure 4. Body Diode Forward Voltage Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage Variation vs. Source Current and Temperature 2.5 $R_{\text{DS(ON)}}\left[\Omega\right]$,Drain-Source On-Resistance , Reverse Drain Current [A] 10¹ 2.0 V_{GS} = 10V 1.5 10⁰ 1.0 = 201/ 150°C К 0.5 * Notes : 1. V_{GS} = 0V 2. 250µs Pulse Test * Note : T_J = 25°C 0.0 L 0 10 15 20 0.2 10 0.4 0.6 0.8 1.4 1.6 1.8 1.0 1.2 I_D, Drain Current [A] V_{SD}, Source-Drain Voltage [V] **Figure 5. Capacitance Characteristics Figure 6. Gate Charge Characteristics** 12 $$\begin{split} \mathbf{C}_{\mathrm{iss}} &= \mathbf{C}_{\mathrm{gs}} + \mathbf{C}_{\mathrm{gd}} \left(\mathbf{C}_{\mathrm{ds}} = \mathrm{shorted} \right) \\ \mathbf{C}_{\mathrm{oss}} &= \mathbf{C}_{\mathrm{ds}} + \mathbf{C}_{\mathrm{gd}} \\ \mathbf{C}_{\mathrm{rss}} &= \mathbf{C}_{\mathrm{gd}} \end{split}$$ V_{DS} = 100V V_{DS} = 250V 10 V_{GS}, Gate-Source Voltage [V] 1000 V_{DS} = 400V 8 Capacitance [pF] 100 Notes : 1. V_{GS} = 0 V 2. f = 1 MHz 10 * Note : I_D = 5 A 0 15 10⁰ 10 5 10 V_{DS}, Drain-Source Voltage [V] Q_G, Total Gate Charge [nC]





Peak Diode Recovery dv/dt Test Circuit & Waveforms





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